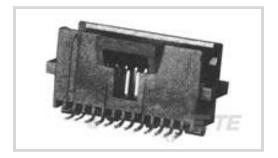
# 147377-8 - ACTIVE

### AMPMODU | AMPMODU System 50

TE Internal #: 147377-8 PCB Mount Header, Vertical, Wire-to-Board / Board-to-Board, 100 Position, .05 in [1.27 mm] Centerline, Fully Shrouded, Gold, AMPMODU System 50

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board, Wire-to-Board

Number of Positions: 100

Number of Rows: 2

#### Features

#### Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board, Wire-to-Board

Fully Shrouded



Sealable	No				
Connector & Contact Terminates To	Printed Circuit Board				
Configuration Features					
Connector Contact Load Condition	Fully Loaded				
PCB Mount Orientation	Vertical				
Number of Positions	100				
Number of Rows	2				
Electrical Characteristics					
Dielectric Withstanding Voltage (Max)	500 V				
Operating Voltage	30 VAC				
Body Features					
Primary Product Color	Black				
Contact Features					
	150 µin				
Contact Shape & Form	Round				

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Contact Mating Area Plating Material Finish	Bright			
PCB Contact Termination Area Plating Material	Tin			
Contact Base Material	Phosphor Bronze			
Contact Mating Area Plating Material	Gold			
Contact Type	Pin			
Contact Current Rating (Max)	1 A			
Termination Features				
	.031 in			
Termination Method to Printed Circuit Board	Surface Mount			
Mechanical Attachment				
Mating Retention	With			
Panel Mount Feature	With			
Mating Alignment	With			
Mating Alignment Type	Latched			
PCB Mount Retention	Without			
PCB Mount Alignment	Without			
Connector Mounting Type	Board Mount			
eenneeter meanting type				

#### Housing Features

Centerline (Pitch)	1.27 mm[.05 in]				
Housing Material	PPA				
Dimensions					
	.1 in				
Usage Conditions					
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]				
Operation/Application					
Solder Process Feature	Board Standoff				
Circuit Application	Power & Signal				
Industry Standards					
Approved Standards	CSA LR7189, UL E28476				
UL Flammability Rating	UL 94V-0				
Packaging Features					
Packaging Quantity	250				

**C** For support call+1 800 522 6752

PCB Mount Header, Vertical, Wire-to-Board / Board-to-Board, 100 Position, .05 in [1.27 mm] Centerline, Fully Shrouded, Gold, AMPMODU System 50



Packaging Type

Tape & Reel

#### **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU

EU ELV Directive 2000/53/EC

China RoHS 2 Directive MIIT Order No 32, 2016

EU REACH Regulation (EC) No. 1907/2006

Not Compliant

Not Compliant

Restricted Materials Above Threshold

Current ECHA Candidate List: JUNE 2022 (224)

Candidate List Declared Against: JUL 2021

(219)

SVHC > Threshold:

Pb (13% in component)

Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Reflow solder capable to 260°C

Halogen Content

Solder Process Capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## **Compatible Parts**

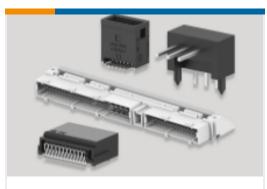


PCB Mount Header, Vertical, Wire-to-Board / Board-to-Board, 100 Position, .05 in [1.27 mm] Centerline, Fully Shrouded, Gold, AMPMODU System 50





## Also in the Series | AMPMODU System 50



PCB Headers & Receptacles(1014)

## Customers Also Bought



TE Part #1-213781-0	TE Part #282888-7	TE Part #499922-5	TE Part #5745085-2
CPC RCPT ASSY SIZE 23-19,S/L	TERMI-BLOK PCB 9 POS. 5 mm PIT	024 UNIV HDR SP 4S 15DP STD L1	HD-20 RCPT 25P RA 478
	Contraction of the second s		
TE Part #641213-8	TE Part #745055-1	TE Part #1-103328-4	TE Part #104450-7
08P MTA100 HDR ASSY PO/ST 30AU	50 PLUG SP/AP INSRT	28 MODII HDR DRST B/A .100CL	08 MTE HDR SRST LATCH W/HLDWN



PCB Mount Header, Vertical, Wire-to-Board / Board-to-Board, 100 Position, .05 in [1.27 mm] Centerline, Fully Shrouded, Gold, AMPMODU System 50



#### Documents

Product Drawings 100 SYS50 SMT HDRDR SHD W/O HD

English

CAD Files

3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_147377-8\_J.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_147377-8\_J.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_147377-8\_J.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Application Specification

English

Product Environmental Compliance TE Material Declaration

English